

UA2725

Gain Block

Data Sheet

DS-2725-01

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UA2725**Gain Block**

1. Product Description

The UA2725 is a wideband LNA MMIC with an internal input/output matching, high/low gain control, and packaged in a 6-pin SOT363 plastic package.

2. Features

- Single 3.3V power supply
- Internally matched to 50Ω
- Low noise figure: 1.9dB at 2.5GHz, 1.6dB at 0.4GHz.
- Very wide frequency over 0.05 to 4GHz
- Flat 20dB gain up to 2.2GHz
- Unconditionally stable
- P1dB over -1.5dBm at 2.5GHz
- High/Low gain control

3. Typical Applications

- DBS
- LNB IF Amplifier
- DVB
- Cable
- ISM
- General Purpose

4. Pin Configuration

Table 1. Pin Descriptions

Pin #	Description
1	V_{GC}
2, 5	GND1
3	RF out
4	GND2
6	RF in

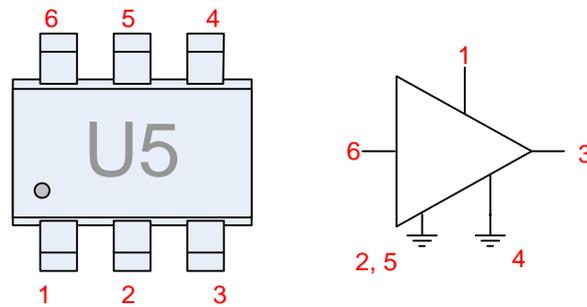


Figure 1. Simplified Outline (SOT363) and Symbol

5. Application Circuit

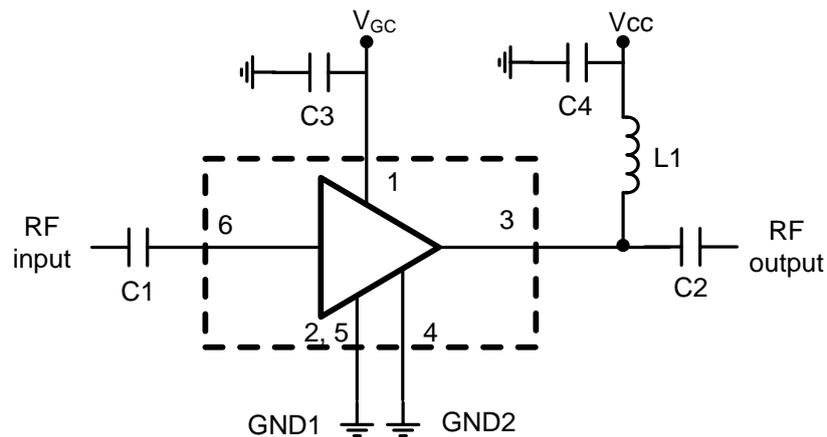


Figure 2. Operating Condition for the Application Circuit

$C1=C2=100\text{pF}$, $C3=C4=0.1\mu\text{F}$. The nominal value of the RF choke, $L1$ is 33nH . Increasing the inductor value will shift the curve towards the lower frequency region. The operating frequency can be lowered to 50 MHz when $L1$ is larger than 220nH .

6. PCB Layout Design Guide

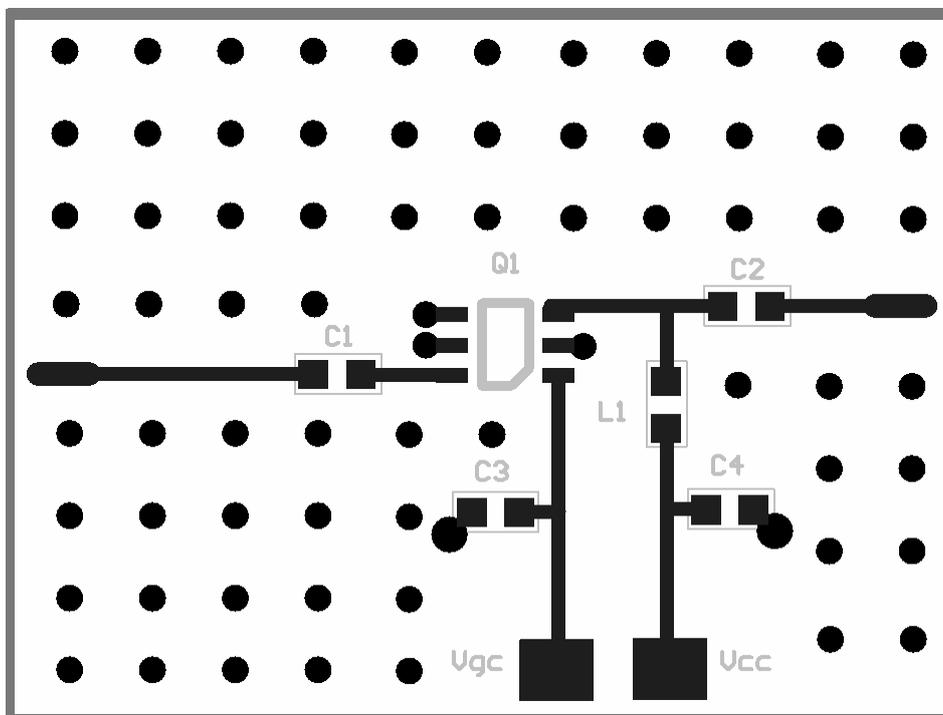


Figure 3. GND via hole

Notes:

1. Each ground pin must have individual via hole.
2. No DC or signal line on the bottom of IC

7. Operating Condition

Table 2. Absolute Maximum Ratings

Symbol	Parameters	Conditions	Typ.	Max.	Unit
V _{cc}	DC Supply Voltage	RF input AC coupled	-	4	V
I _{cc}	Supply Current		-	30	mA
P _{tot}	Total Power Dissipation	T _a ≤ 90 °C	-	120	mW
T _{st}	Storage Temperature		-65	150	°C
T _j	Operating Junction Temperature		-40	150	°C
P _D	Maximum Drive Power		-	-5	dBm

Table 3. Thermal Characteristics

Symbol	Parameters	Conditions	Value	Unit
R _{th}	Thermal Resistance from Junction to Solder Point	P _{tot} = 85 mW; T _a ≤ 90 °C	300	K/W

8. Electrical Characteristics

Table 4. High/Low Gain Control Pin

State	Pin 1	Chapter
High Gain Mode	$V_{GC} = 3.3\text{ V}$	8.1.
Low Gain Mode	$V_{GC} = 0\text{ V}$	8.2.

8.1. High Gain Mode

Table 5. Electrical Characteristics with L1 = 33nH

$V_{CC} = 3.3\text{V}$; $I_{CC} = 12\text{mA}$; $V_{GC} = 3.3\text{V}$; unless otherwise specified.

Symbol	Parameters	Conditions	Min.	Typ.	Max.	Unit
I_{CC}	Supply Current		-	12	-	mA
$ S_{21} ^2$	Insertion Power Gain	f = 400 MHz	-	19.5	-	dB
		f = 0.9 GHz	-	20	-	dB
		f = 2.5 GHz	-	20	-	dB
		f = 3 GHz	-	19.5	-	dB
		f = 4 GHz	-	17	-	dB
$ S_{11} ^2$	Input Return Loss	f = 0.4 GHz	10	-	-	dB
		f = 2.5 GHz	10	-	-	dB
		f = 4 GHz	10	-	-	dB
$ S_{22} ^2$	Output Return Loss	f = 0.4 GHz	10	-	-	dB
		f = 2.5 GHz	10	-	-	dB
		f = 4 GHz	10	-	-	dB
$ S_{12} ^2$	Isolation	f = 0.4 GHz	-	31	-	dB
		f = 2.5 GHz	-	31.5	-	dB
		f = 4 GHz	-	34	-	dB
NF	Noise Figure	f = 0.4 GHz	-	1.6	-	dB
		f = 2.5 GHz	-	1.9	-	dB
		f = 4 GHz	-	2.6	-	dB
BW	Bandwidth	at $ S_{21} ^2$ -3 dB below flat gain at 1 GHz	-	3.9	-	GHz
K	Stability Factor	f = 0.9 GHz	-	2	-	-
		f = 2.5 GHz	-	2	-	-
$P_{L(sat)}$	Saturated Load Power	f = 0.9 GHz	-	5	-	dBm
		f = 2.5 GHz	-	4	-	dBm
$P_{L,1dB}$	Output P_{1dB}	at 1 dB gain compression; f = 0.9 GHz	-	-1	-	dBm
		at 1 dB gain compression; f = 2.5 GHz	-	-1.5	-	dBm
I_{GC}	Control Current	$V_{GC}=3.3\text{V}$	-	0.9	-	mA



Caution: ESD sensitive.

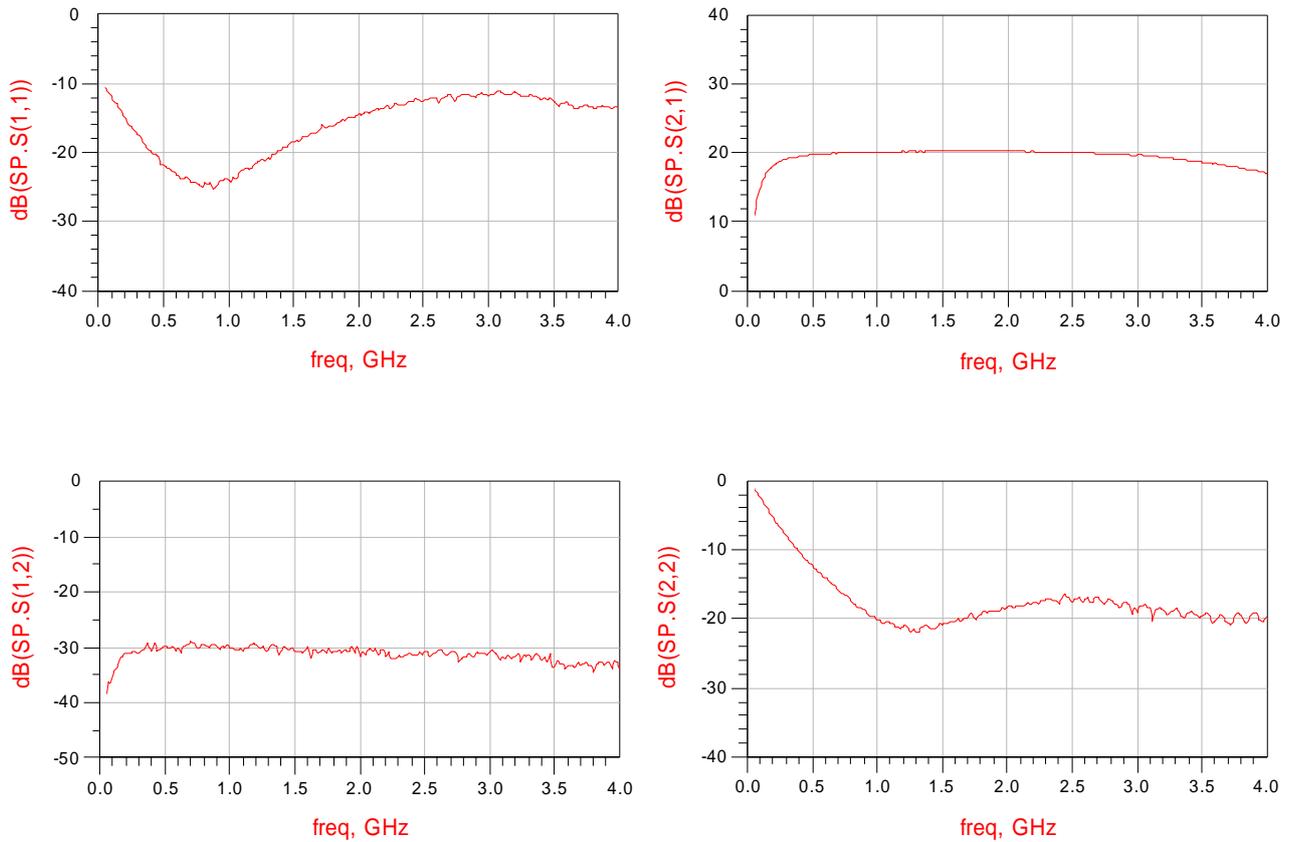


Figure 4. S-parameter ($V_{cc}=3.3V$, $I_{cc}=12mA$, $V_{GC} = 3.3V$, $P_{in}=-40dBm$, $Z_0=50\Omega$) with $L1=33nH$

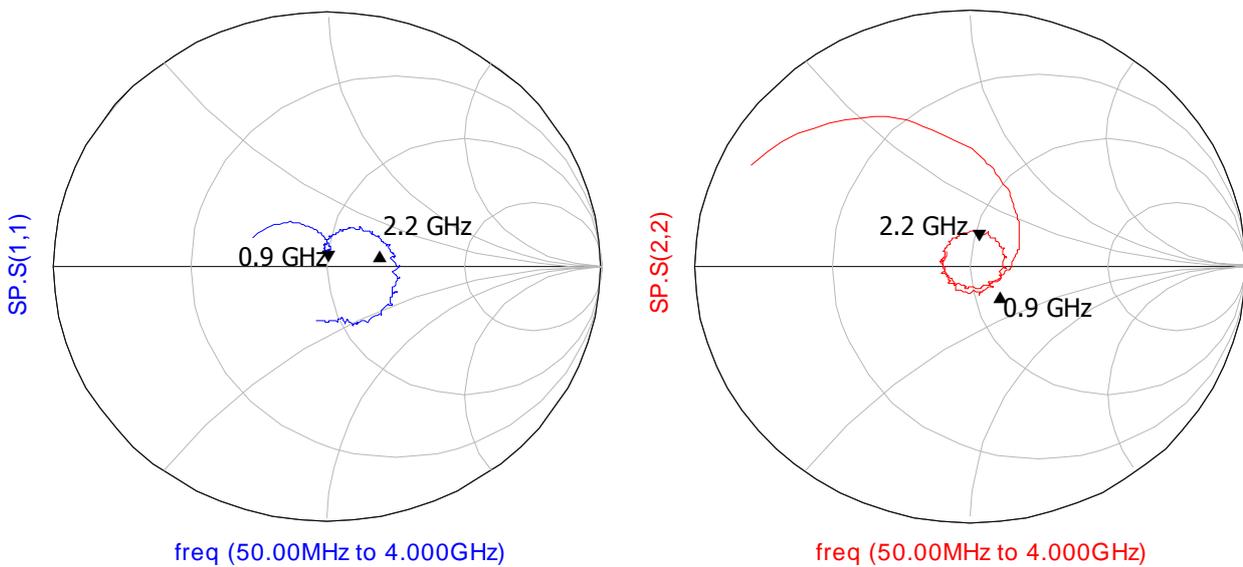


Figure 5. S_{11} & S_{22} ($V_{cc}=3.3V$, $I_{cc}=12mA$, $V_{GC} = 3.3V$, $P_{in}=-40dBm$, $Z_0=50\Omega$) with $L1=33nH$

Table 6. Electrical Characteristics with L1=120nH (High gain mode)

V_{CC} = 3.3V; I_{CC} = 12mA; V_{GC} = 3.3V; unless otherwise specified.

Symbol	Parameters	Conditions	Min.	Typ.	Max.	Unit
I _{CC}	Supply Current		-	12	-	mA
S ₂₁ ²	Insertion Power Gain	f = 100 MHz	-	19.4	-	dB
		f = 0.5 GHz	-	19.7	-	dB
		f = 0.9 GHz	-	19.7	-	dB
		f = 1.5 GHz	-	19.7	-	dB
		f = 2 GHz	-	19.6	-	dB
S ₁₁ ²	Input Return Loss	f = 100MHz	10	-	-	dB
		f = 0.9 GHz	10	-	-	dB
		f = 2 GHz	10	-	-	dB
S ₂₂ ²	Output Return Loss	f = 100 MHz	10	-	-	dB
		f = 0.9 GHz	10	-	-	dB
		f = 2 GHz	10	-	-	dB
S ₁₂ ²	Isolation	f = 100 MHz	-	30	-	dB
		f = 0.9 GHz	-	30	-	dB
		f = 2 GHz	-	31	-	dB
NF	Noise Figure	f = 100 MHz	-	1.5	-	dB
		f = 0.9 GHz	-	1.6	-	dB
		f = 2 GHz	-	1.8	-	dB
BW	Bandwidth	at S ₂₁ ² -3 dB below flat gain at 0.9 GHz	-	3.2	-	GHz
K	Stability Factor	f = 100 MHz	-	2	-	-
		f = 2 GHz	-	1.8	-	-
P _{L(sat)}	Saturated Load Power	f = 100 MHz	-	5	-	dBm
		f = 2 GHz	-	4	-	dBm
P _{L,1 dB}	Output P _{1dB}	at 1 dB gain compression; f = 0.1 GHz	-	-1	-	dBm
		at 1 dB gain compression; f = 2 GHz	-	-1.5	-	dBm
I _{GC}	Control Current	V _{GC} =3.3V	-	0.9	-	mA

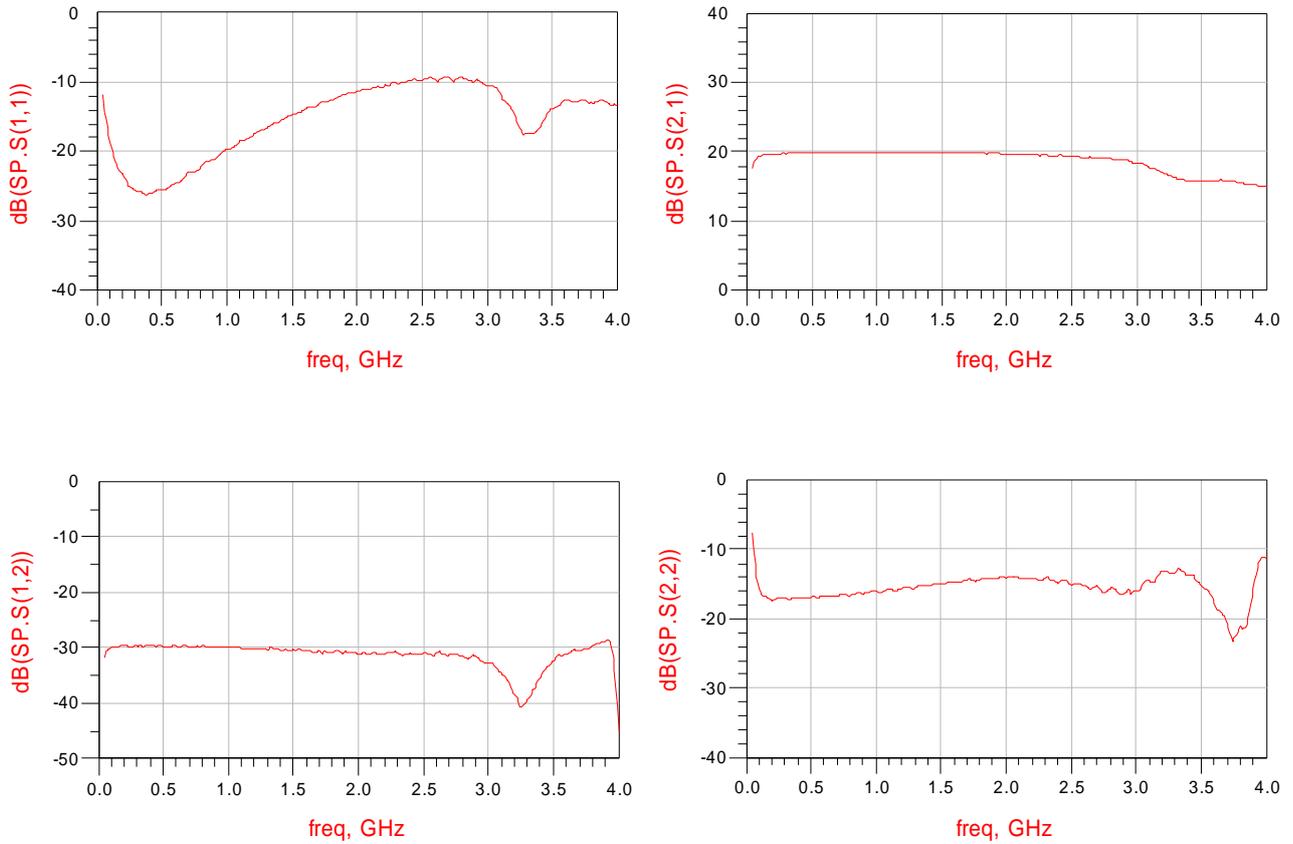


Figure 6. S-parameter ($V_{cc}=3.3\text{V}$, $I_{cc}=12\text{mA}$, $V_{GC}=3.3\text{V}$, $P_{in}=-40\text{dBm}$, $Z_0=50\Omega$) with $L1=120\text{nH}$

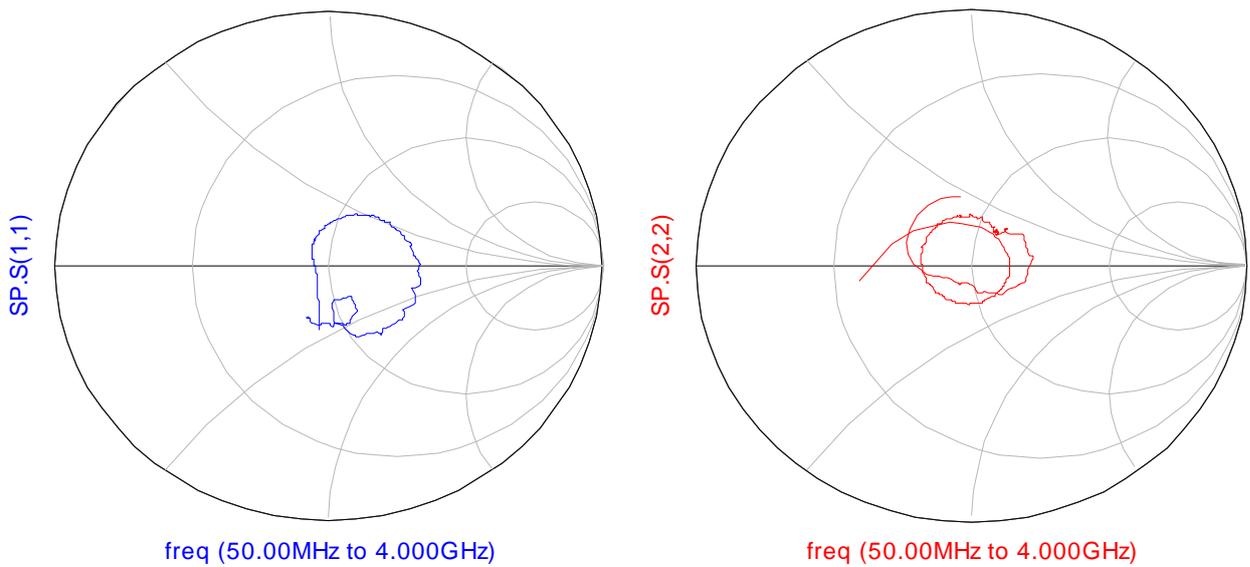


Figure 7. S_{11} & S_{22} ($V_{cc}=3.3\text{ V}$, $I_{cc}=12\text{mA}$, $V_{GC}=3.3\text{V}$, $P_{in}=-40\text{dBm}$, $Z_0=50\Omega$) with $L1=120\text{nH}$

Table 7. Electrical Characteristics with L1=220nH

V_{CC} = 3.3V; I_{CC} = 12mA; V_{GC} = 3.3V; unless otherwise specified.

Symbol	Parameters	Conditions	Min.	Typ.	Max.	Unit
I _{CC}	Supply Current		-	12	-	mA
S ₂₁ ²	Insertion Power Gain	f = 50 MHz	-	19	-	dB
		f = 100 MHz	-	19.5	-	dB
		f = 0.4 GHz	-	19.7	-	dB
		f = 0.9 GHz	-	19.7	-	dB
		f = 1.5 GHz	-	19.7	-	dB
S ₁₁ ²	Input Return Loss	f = 50MHz	10	-	-	dB
		f = 0.4 GHz	10	-	-	dB
		f = 1.5 GHz	10	-	-	dB
S ₂₂ ²	Output Return Loss	f = 50 MHz	10	-	-	dB
		f = 0.4 GHz	10	-	-	dB
		f = 1.5 GHz	10	-	-	dB
S ₁₂ ²	Isolation	f = 50 MHz	-	31	-	dB
		f = 0.4 GHz	-	30	-	dB
		f = 1.5 GHz	-	31	-	dB
NF	Noise Figure	f = 50 MHz	-	1.5	-	dB
		f = 0.4 GHz	-	1.6	-	dB
		f = 1.5 GHz	-	1.7	-	dB
BW	Bandwidth	at S ₂₁ ² -3 dB below flat gain at 0.5 GHz	-	2.5	-	GHz
K	Stability Factor	f = 50 MHz	-	2	-	-
		f = 0.9 GHz	-	1.9	-	-
P _{L(sat)}	Saturated Load Power	f = 50 MHz	-	5	-	dBm
		f = 0.9 GHz	-	4	-	dBm
P _{L,1dB}	Output P _{1dB}	at 1 dB gain compression; f = 50 MHz	-	-0.5	-	dBm
		at 1 dB gain compression; f = 0.9 GHz	-	-1	-	dBm
I _{GC}	Control Current	V _{GC} =3.3V	-	0.9	-	mA

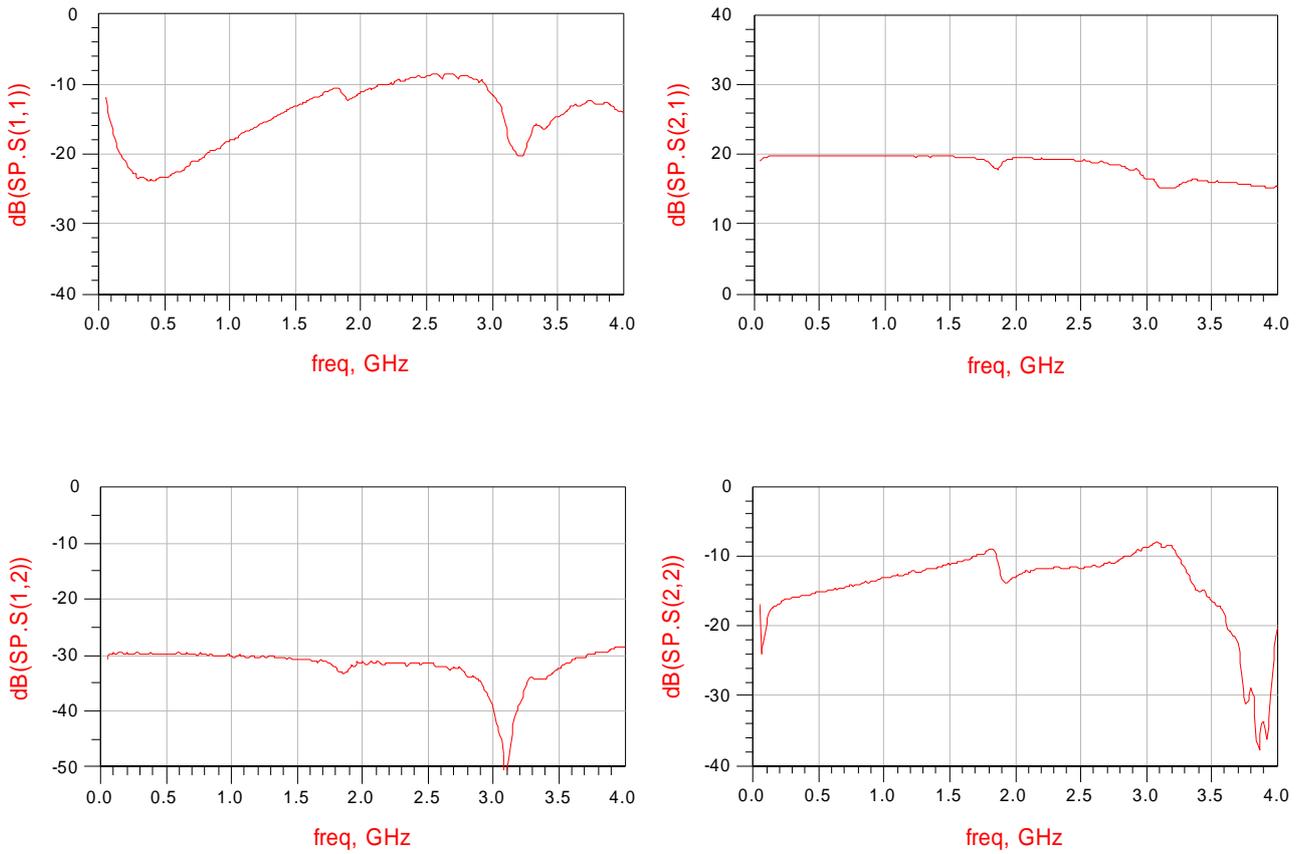


Figure 8. S-parameter ($V_{cc}=3.3V$, $I_{cc}=12mA$, $V_{GC}=3.3V$, $P_{in}=-40dBm$, $Z_0=50\Omega$) with $L1=220nH$

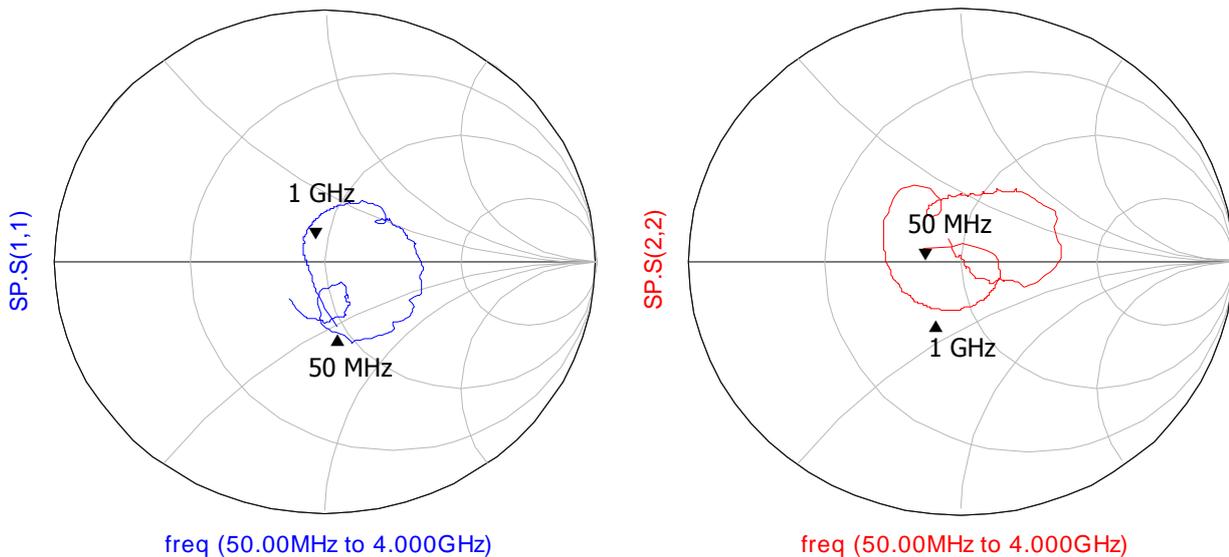


Figure 9. S_{11} & S_{22} ($V_{cc}=3.3V$, $I_{cc}=12mA$, $V_{GC}=3.3V$, $P_{in}=-40dBm$, $Z_0=50\Omega$) with $L1=220nH$

8.2. Low Gain Mode

Table 8. Electrical Characteristics with L1=120nH

V_{CC} = 3.3V; I_{CC} = 5mA; V_{GC} = 0V; unless otherwise specified.

Symbol	Parameters	Conditions	Min.	Typ.	Max.	Unit
I _{CC}	Supply Current		-	5	-	mA
S ₂₁ ²	Insertion Power Gain	f = 100 MHz	-	-18	-	dB
		f = 0.5 GHz	-	-17	-	dB
		f = 0.9 GHz	-	-17	-	dB
		f = 1.5 GHz	-	-18	-	dB
		f = 2 GHz	-	-18.5	-	dB
S ₁₁ ²	Input Return Loss	f = 100MHz	2	-	-	dB
		f = 0.9 GHz	2	-	-	dB
		f = 2 GHz	2	-	-	dB
S ₂₂ ²	Output Return Loss	f = 100 MHz	4.5	-	-	dB
		f = 0.9 GHz	4	-	-	dB
		f = 2 GHz	4	-	-	dB
S ₁₂ ²	Isolation	f = 100 MHz	-	20	-	dB
		f = 0.9 GHz	-	21	-	dB
		f = 2 GHz	-	23.5	-	dB
NF	Noise Figure	f = 100 MHz	-	1.6	-	dB
		f = 0.9 GHz	-	1.7	-	dB
		f = 2 GHz	-	1.8	-	dB
BW	Bandwidth	at S ₂₁ ² -3 dB below flat gain at 0.9 GHz	-	4.5	-	GHz
K	Stability Factor	f = 100 MHz	-	9.5	-	-
		f = 2 GHz	-	14.5	-	-
P _{In,1dB}	Output P _{1dB}	at 1 dB gain compression; f = 0.1 GHz	-	2	-	dBm
		at 1 dB gain compression; f = 2 GHz	-	0	-	dBm
I _{GC}	Control Current	V _{GC} =0V	-	-4	-	mA

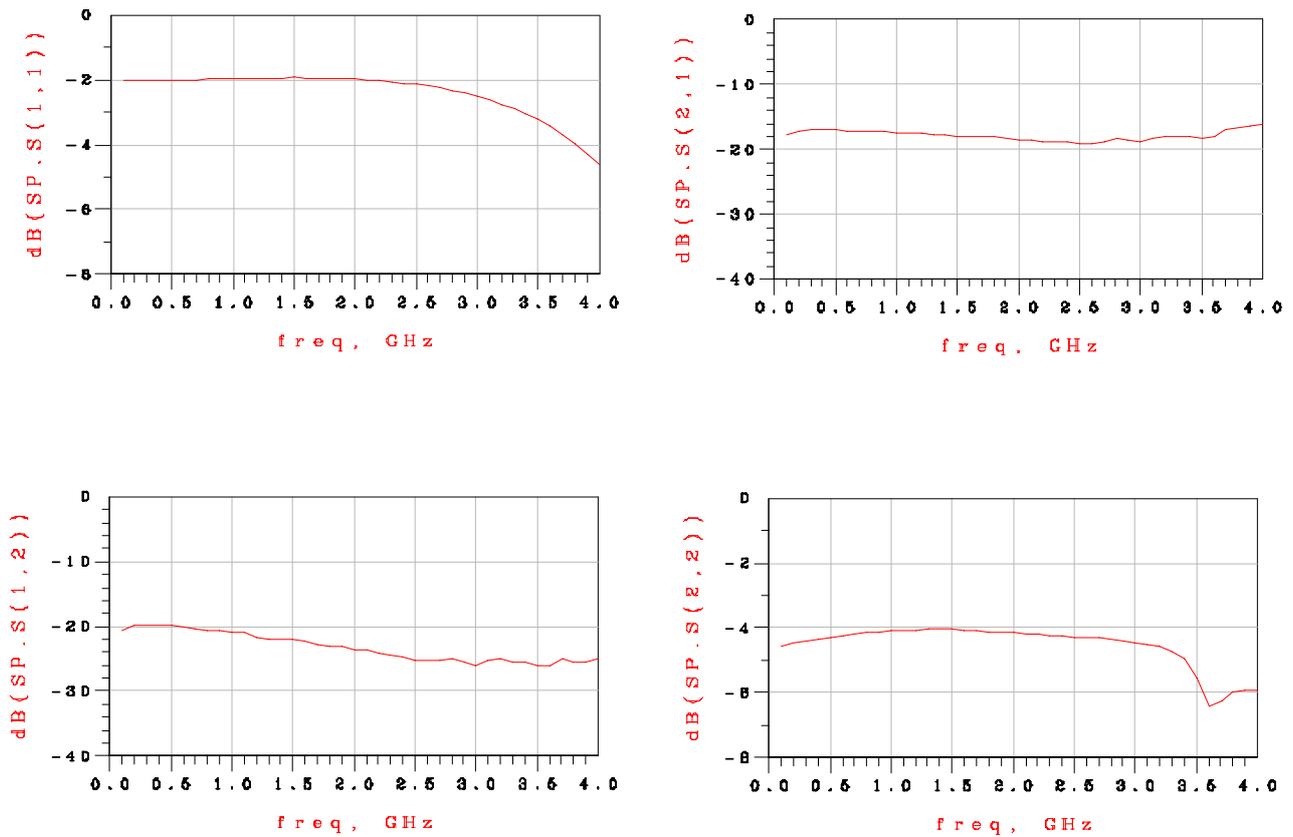


Figure 10. S-parameter ($V_{cc}=3.3\text{ V}$, $I_{cc}=5\text{ mA}$, $V_{GC}=0\text{ V}$, $P_{in}=-40\text{ dBm}$, $Z_0=50\Omega$) with $L1=120\text{ nH}$

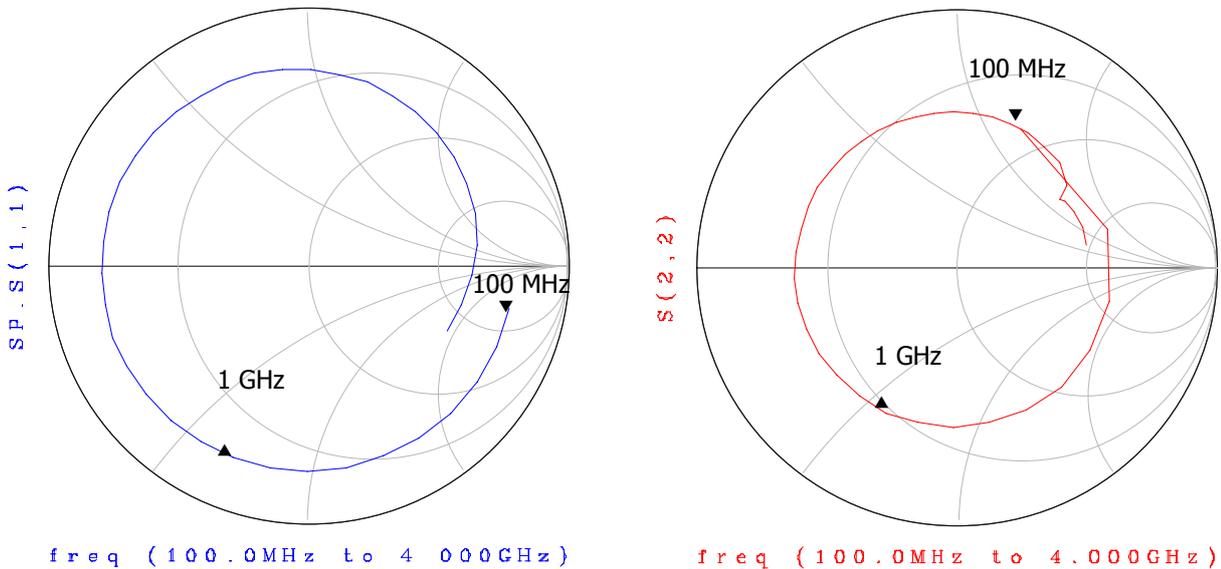


Figure 11. S_{11} & S_{22} ($V_{cc}=3.3\text{ V}$, $I_{cc}=5\text{ mA}$, $V_{GC}=0\text{ V}$, $P_{in}=-40\text{ dBm}$, $Z_0=50\Omega$) with $L1=120\text{ nH}$

9. Package Drawing

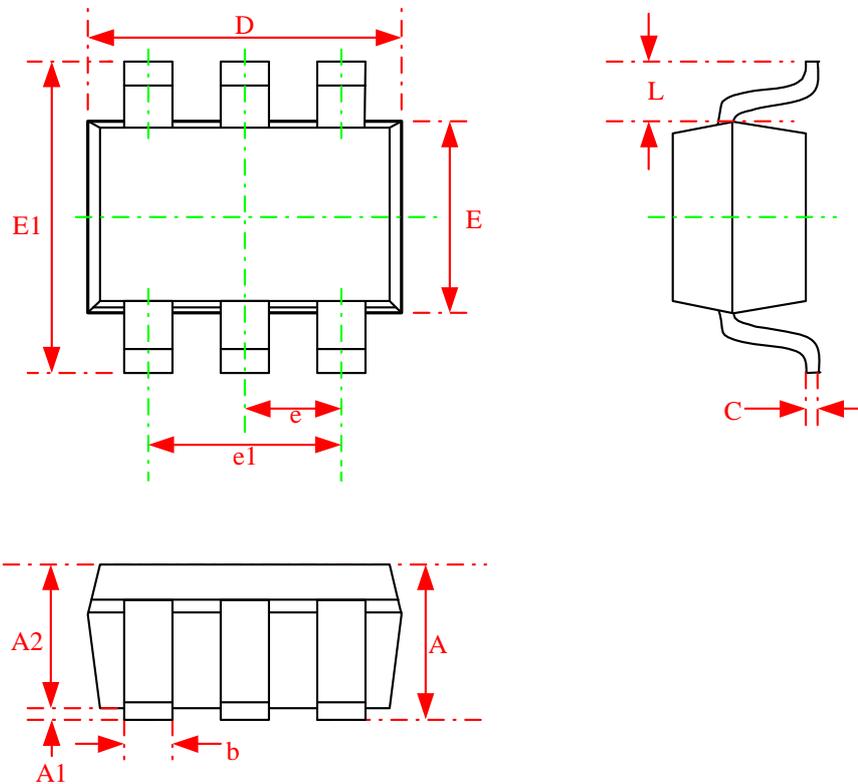


Figure 12. Package Outline

Table 9. Dimension Description

Symbol	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.90	1.10	.038	.044
A1	0.025	0.10	.001	.004
A2	0.875	1.00	.035	.040
b	0.20	0.40	.008	.016
C	0.10	0.15	.004	.006
D	1.90	2.10	.076	.084
E	1.15	1.35	.046	.054
E1	2.00	2.20	.080	.088
e	0.65 BSC.		.026 BSC.	
e1	1.30 BSC.		.052 BSC.	
L	0.425 REF.		.017 BSC.	

Revision History

Revision	Date	Description of Change
0.0	2006/8/7	Original.
1.0	2008/1/17	Add High/Low gain control pin table and PCB layout design guide.

Contact UBEC:

Headquarters

Address: 7F-1, No. 192, Dongguang Rd., Hsinchu, 300 Taiwan

Tel: +886-3-5729898

Fax: +886-3-5718599

Website: <http://www.ubec.com.tw>

Sales Services

Tel: +886-3-5729898

Fax: +886-3-5718599

E-mail: sales@ubec.com.tw

FAE Services

Tel: +886-3-5729898

Fax: +886-3-5718599

E-mail: fae@ubec.com.tw

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